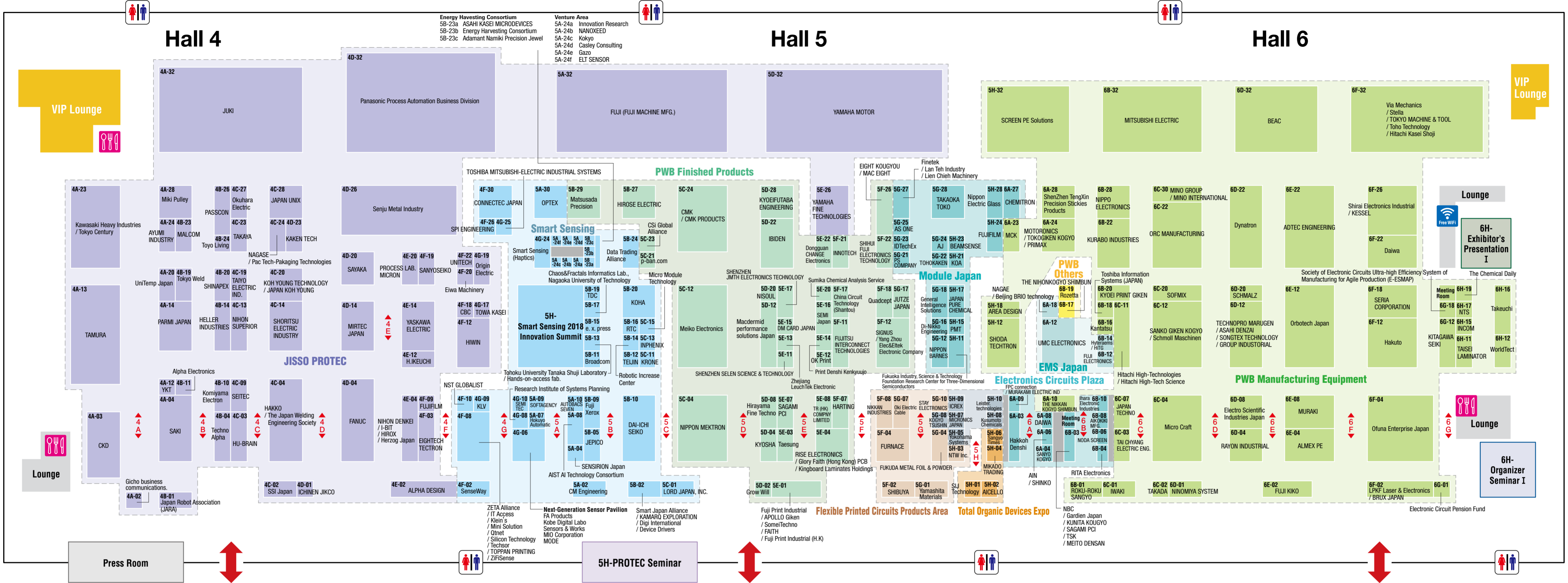
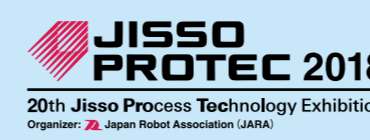


Floor Map / List of Exhibitors

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5C-04 7D-50

5C-12

5C-24 7D-50

5F-08 7D-50

5F-11

6A-09

6D-08

6D-22

6E-12

Company Name	booth No.	Exhibition
Adamant Namiki Precision Jewel	5B-23a	Smart Sensing
ADTEC ENGINEERING	6E-22	PWB Technology
AICELLO	5H-02	Total Organic Devices Expo
AIKOKI MFG.	6B-08	Electronics Circuits Plaza
AIN	6A-06	Electronics Circuits Plaza
AIST AI Technology Consortium	5A-08	Smart Sensing
AS ONE	5F-24	Module Japan
ALMEX PE	6E-04	PWB Technology
ALPHA DESIGN	4E-02	JISSO PROTEC
Alpha Electronics	4B-11	JISSO PROTEC
APOLLO Giken	5E-01	PWB Technology
ARCA DESIGN	5H-18	PWB Technology
AS ONE	5E-25	Module Japan
ASAHI DENZAI	6D-12	PWB Technology
ASAHI KASEI MICRODEVICES	5B-23a	Smart Sensing
AUTOBACS SEVEN	5A-10	Smart Sensing
AYUMI INDUSTRY	4A-24	JISSO PROTEC
BEAC	6D-32	PWB Technology
BEAMSENSE	5H-23	Module Japan
Beijing BRIO Electronic Technologies	6A-18	EMS Japan
Broadcom	5B-11	Smart Sensing
BRUX JAPAN	6F-02	PWB Technology
Casley Consulting	5A-24d	Smart Sensing
CBC	4F-18	JISSO PROTEC
Chaos&Fractals Informatics Lab., Nagasaki University of Technology	4B-17	Smart Sensing
CHEMTRON	6A-27	Module Japan
China Circuit Technology (Shantou)	5F-17	PWB Technology
CKD	4A-03	JISSO PROTEC
CM Engineering	5A-02	Smart Sensing
CMK	5C-24	PWB Technology
CMK PRODUCTS	5C-24	PWB Technology
CONNECTEC JAPAN	4F-30	Smart Sensing
CSI Global Alliance	5C-23	PWB Technology
DAL-ICHI SEIKO	5B-10	Smart Sensing
Daiwa	6F-22	PWB Technology
DAIWA	6A-08	Electronics Circuits Plaza
Data Trading Alliance	5B-24	Smart Sensing
Device Drivers	5B-02	Smart Sensing
Di-Nikko Engineering	5G-16	Module Japan
Digi International	5B-02	Smart Sensing
DM CARD JAPAN	5E-15	PWB Technology
Dongguan CHANGE Electronics	5E-22	PWB Technology
Dynatron	6C-22	PWB Technology
e. x. press	5B-15	Smart Sensing
EIGHT KOUGYOU	5F-26	PWB Technology
EIGHTTECH TECTRON	4F-03	JISSO PROTEC
Eiwa Machinery	4F-20	JISSO PROTEC
Electro Scientific Industries Japan	6D-08	PWB Technology
Electronic Circuit Pension Fund	6G-01	PWB Technology
ELT SENSOR	5A-24f	Smart Sensing
FA Products	4G-06	Smart Sensing
FAITH	5E-01	PWB Technology
FANUC	4D-04	JISSO PROTEC
Finetek	5G-27	Module Japan
FPC connection	6A-09	Electronics Circuits Plaza
FUJI (FUJI MACHINE MFG.)	5A-32	JISSO PROTEC
FUJI ELECTRONICS	6B-12	EMS Japan
FUJI KIKO	6E-02	PWB Technology
Fuji Print Industrial	5E-01	PWB Technology

Company Name	booth No.	Exhibition
Fuji Print Industrial (H.K)	5E-01	PWB Technology
Fuji Xerox	5B-09	Smart Sensing
FUJIFILM	4F-09	JISSO PROTEC
FUJIFILM	5H-24	Module Japan
FUJITSU INTERCONNECT TECHNOLOGIES	5F-11	PWB Technology
FUKUDA METAL FOIL & POWDER	5G-04	Flexible Printed Circuits Products Area
Fukuoka Industry, Science & Technology Foundation Research Center for Three-Dimensional Semiconductors	5H-11	Module Japan
G	5F-04	Flexible Printed Circuits Products Area
Gardian Japan	6B-03	Electronics Circuits Plaza
Gazo	5A-24a	Smart Sensing
General Intelligence Solutions	5E-18	Module Japan
Gicho business communications	4A-02	JISSO PROTEC
Glory Faith (Hong Kong) PCB	5E-04	PWB Technology
GROUP INDUSTRIAL	6D-12	PWB Technology
Grow Will	5D-02	PWB Technology
H	4E-12	JISSO PROTEC
H.I.K.E.U.C.H.I	4C-04	JISSO PROTEC
HAKKO	6A-03	Electronics Circuits Plaza
Hakoh Denzhi	6F-12	PWB Technology
Hakuto	5F-07	PWB Technology
HARTING	4B-14	JISSO PROTEC
HELLER INDUSTRIES	4E-04	JISSO PROTEC
Herzog Japan	5D-08	PWB Technology
Hirayama Fine Techno	5D-08	PWB Technology
HIROSE ELECTRIC	4E-04	JISSO PROTEC
HIROX	6C-11	PWB Technology
Hitachi High-Tech Science	6C-11	PWB Technology
Hitachi High-Tech Technologies	6C-11	PWB Technology
Hitachi Kasei Shoji	6F-32	PWB Technology
HIWIN	4F-12	JISSO PROTEC
HIWIN	5A-07	Smart Sensing
Hokuyo Automatic	5A-07	Smart Sensing
HU-BRAIN	4C-03	JISSO PROTEC
Hyteraems / HITG	6B-14	EMS Japan
I-BIT	4E-04	JISSO PROTEC
IBIDEN	5D-22	PWB Technology
ICHIMEN JIKCO	4D-01	JISSO PROTEC
I-CREX	5H-09	WIRE Japan Show
IDTechEx	5B-23	Module Japan
Ihara Electronic Industries	6B-10	Electronics Circuits Plaza
INCOM	6H-15	PWB Technology
INNOVTECH	5F-21	PWB Technology
Innovation Research	5A-24a	Smart Sensing
INPHENIX	5C-13	Smart Sensing
IT Access	4F-08	Smart Sensing
IWAKI	6C-01	PWB Technology
J	4C-20	JISSO PROTEC
JAPAN KOH YOUNG	5H-17	Module Japan
JAPAN PURE CHEMICAL	4B-01	JISSO PROTEC
Japan Robot Association (JARA)	4B-01	JISSO PROTEC
JAPAN TECHNO	6C-07	PWB Technology
JAPAN UNIX	4C-28	JISSO PROTEC
JEPICO	5B-05	Smart Sensing
JUKI	4A-32	JISSO PROTEC
JUTZE JAPAN	5E-17	PWB Technology
KANEN TECH	4D-23	JISSO PROTEC
KAKAMORI EXPLORATION	5C-04	Smart Sensing
KANTATSU	6B-16	PWB Technology
Kawasaki Heavy Industries	4A-23	JISSO PROTEC
KESSEL	6F-26	PWB Technology
Kingboard Laminates Holdings	5E-04	PWB Technology
KITAGAWA SEIKI	6E-12	PWB Technology

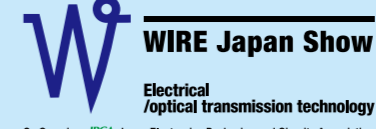
Company Name	booth No.	Exhibition
Klein's	4F-08	Smart Sensing
KLV	4F-08	Smart Sensing
KOA	5H-21	Module Japan
Kobe Digital Labo	4G-06	Smart Sensing
KOGYO TSUSHIN	5G-08	Flexible Printed Circuits Products Area
KOH YOUNG TECHNOLOGY	4C-20	JISSO PROTEC
KOHA	5B-20	Smart Sensing
Kokyo	5A-24c	Smart Sensing
Komiyama Electron	4B-10	JISSO PROTEC
KRONE	5C-11	Smart Sensing
KUNITA KOUGYO	6B-03	Electronics Circuits Plaza
KURABO INDUSTRIES	6B-22	PWB Technology
Leister Technologies	5B-27	Module Japan
Lien Chieh Machinery	5H-03	WIRE Japan Show
LORD JAPAN, INC.	5C-01	Smart Sensing
LPKF Laser & Electronics	6F-02	PWB Technology
MAC EIGHT	5F-26	PWB Technology
Macdermid performance solutions Japan	5D-12	PWB Technology
MALCOM	4B-23	JISSO PROTEC
Matsusada Precision	5H-03	Smart Sensing
MCK	6A-23	PWB Technology
Meiko Electronics	5C-12	PWB Technology
MEITO DENSAN	6B-03	Electronics Circuits Plaza
Micro Craft	6C-04	PWB Technology
Micro Module Technology	5C-15	Smart Sensing
MICRONICS JAPAN	5G-27	Module Japan
MIKADO TRADING	5H-04	Total Organic Devices Expo
Miki Pulley	4A-28	JISSO PROTEC
Mini Solution	4F-08	Smart Sensing
MINO GROUP	6C-30	Smart Sensing
MINO INTERNATIONAL	6C-30	PWB Technology
MINO TECH	4C-06	Smart Sensing
MIRTEC JAPAN	4D-14	JISSO PROTEC
MITSUBISHI ELECTRIC	6B-32	PWB Technology
MODE	4G-06	Smart Sensing
MODE	6A-24	PWB Technology
MOTORONICS	6A-09	Electronics Circuits Plaza
MURAKAMI ELECTRIC IND	6E-08	Electronics Circuits Plaza
MURAKI	6E-08	Electronics Circuits Plaza
NAGAE	6A-18	EMS Japan
NAGASE	4C-24	JISSO PROTEC
NAOXXEED	5A-24b	Smart Sensing
NBC	6B-03	Electronics Circuits Plaza
NIHON DENKEI	5B-09	Smart Sensing
NIHON SUPERIOR	4C-13	JISSO PROTEC
NIKKAN INDUSTRIES	5F-08	Flexible Printed Circuits Products Area
NINOMIYA SYSTEM	6D-01	PWB Technology
NIPPPO ELECTRONICS	6B-28	PWB Technology
NIPPON BARNES	5G-12	Module Japan
NIPPON ELECTRIC GLASS	5G-28	Module Japan
NIPPON MEKTRON	6F-26	PWB Technology
NISOU	5D-20	PWB Technology
NODA SCREEN	6B-06	Electronics Circuits Plaza
NST GLOBALIST	4F-10	Smart Sensing
NTS	6H-17	PWB Technology
NTW Inc.	5H-03	Flexible Printed Circuits Products Area

Company Name	booth No.	Exhibition
Ovuna Enterprise Japan	6F-04	PWB Technology
OK Print	5E-12	PWB Technology
Ok Electric Cable	5G-07	Flexible Printed Circuits Products Area
Okuhara Electric	4C-27	JISSO PROTEC
OPTEX	5A-30	Smart Sensing
Orbotech Japan	6E-12	PWB Technology
ORC MANUFACTURING	6C-22	PWB Technology
Origin Electric	4G-19	JISSO PROTEC
p-ban.com	5C-21	PWB Technology
Pac Tech-Packaging Technologies	4C-24	JISSO PROTEC
Panasonic Process Automation Business Division	4D-32	JISSO PROTEC
PARMI JAPAN	4A-14	JISSO PROTEC
PASSOON	4B-24	JISSO PROTEC
PMT	5H-15	Module Japan
PRIMAX	6A-24	PWB Technology
Print Denshi Kenkyuuo	5E-14	PWB Technology
PROCESS LAB. MICRON	4E-20	JISSO PROTEC
P-S Company	5G-21	Module Japan
Q	4F-08	Smart Sensing
Quadtec	5F-18	PWB Technology
R	6D-04	PWB Technology
RAYON INDUSTRIAL	6D-04	PWB Technology
Research Institute of Systems Planning	4G-08	Smart Sensing
RISE ELECTRONICS	5E-04	PWB Technology
RITA Electronics	6B-04	Electronics Circuits Plaza
Robotic Increase Center	4B-26	JISSO PROTEC
ROKUI-ROKUI SANGYO	6B-01	PWB Technology
Rozetta	6B-19	PWB Technology
S	6B-19	PWB Technology
SAGAMI PCI	5E-07	PWB Technology
SAGAMI PCI	6B-03	Electronics Circuits Plaza
SAKI	4A-04	JISSO PROTEC
Sangyo Times	5H-06	Total Organic Devices Expo
SANKO GIKEN KOGYO	6C-12	PWB Technology
SANYO KOGYO	6A-04	Electronics Circuits Plaza
SANYOSEIKO	4F-19	JISSO PROTEC
SAYAKA	4B-20	JISSO PROTEC
SCHMALZ	6D-20	PWB Technology
SEMIL	5F-11	Smart Sensing
SEMIL	6C-12	PWB Technology
SEMIL	5E-16	PWB Technology
SEMITEC	4E-08	Smart Sensing
Senju Metal Industry	4D-26	JISSO PROTEC
SenseWay	4F-02	Smart Sensing
SENSIRION Japan	5A-04	Smart Sensing
Sensors & Works	4G-06	Smart Sensing
SERIA CORPORATION	6F-18	PWB Technology
SHENZHEN JIMH ELECTRONICS TECHNOLOGY	6E-32	PWB Technology
SHENZHEN SELEN SCIENCE & TECHNOLOGY	5E-11	PWB Technology
Shenzhen TengXin Precision Stickers Products	6A-28	PWB Technology
SHIBUYA	5F-02	Flexible Printed Circuits Products Area
SHIHUI FUJI ELECTRONICS TECHNOLOGY	5F-22	PWB Technology
SHINAPEX	4B-20	JISSO PROTEC
SHIRAI ELECTRIC GLASS	6B-26	Electronics Circuits Plaza
Shirai Electronics Industrial	6F-26	PWB Technology
SHODA TECHTRON	5H-12	PWB Technology
SHORITSU ELECTRIC INDUSTRY	4C-14	JISSO PROTEC
SIGNUS	5F-12	PWB Technology
SIJ Technology	5H-01	Total Organic Devices Expo
Silicon Technology	4F-08	Smart Sensing

Company Name	booth No.	Exhibition
Smart Japan Alliance	5B-02	Smart Sensing
Society of Electronic Circuits Ultra-high Efficiency System of Manufacturing for Agile Production (E-ESMAP)	6E-18	PWB Technology
SOFTAGENCY	6C-20	PWB Technology
SOFMIX	5A-09	Smart Sensing
SOMTECH TECHNOLOGY	5E-01	PWB Technology
SPI ENGINEERING	4F-26	Smart Sensing
SSI Japan	4C-02	JISSO PROTEC
STAY ELECTRONICS	5G-10	Flexible Printed Circuits Products Area
Stella	6F-32	PWB Technology
Sumika Chemical Analysis Service	5E-20	PWB Technology
Taesung	5E-08	PWB Technology
TAI CHYANG ELECTRIC ENG.	6E-03	PWB Technology
TAISEI LAMINATOR	6H-11	PWB Technology
TAIYO ELECTRIC IND.	4C-19	JISSO PROTEC
TAKADA	6C-02	PWB Technology
TAKAKA TOKO	5E-28	Module Japan
TAKAYA	4B-23	JISSO PROTEC
Takuhachi	6H-16	PWB Technology
TAMURA	4A-13	JISSO PROTEC
TDC	5B-19	Smart Sensing
Techno Alpha	4B-04	JISSO PROTEC
TECHNOPRO MARUGEN	6D-12	PWB Technology
TECHNOLOGICAL	4E-23	JISSO PROTEC
TELJIN	5B-12	Smart Sensing
THE CHEMICAL DAILY	6H-19	PWB Technology
The Japan Welding Engineering Society	4C-04	JISSO PROTEC
THE NIHONKOGYO SHIMBUN	6B-17	PWB Technology
THE NIKKAN KOGYO SHIMBUN	6A-10	PWB Technology
Toho Technology	4E-19	JISSO PROTEC
TOHOKAKEN	5G-22	Module Japan
Tohoku University Tanaka Shuji Laboratory/ Hands-on-access fab.	5B-13	Smart Sensing
TOKOGIKEN KOGYO	6A-24	PWB Technology
Tokyo Century	4A-23	JISSO PROTEC
Tokyo Machine & Tool	6A-10	PWB Technology
Tokyo Weld	4B-19	JISSO PROTEC
TOPPAN PRINTING	4F-08	Smart Sensing
Toshiba Information Systems (Japan)	6B-18	PWB Technology
TOSHIBA MITSUBISHI-ELECTRIC INDUSTRIAL SYSTEMS	4G-25	Smart Sensing
TOWA KASEI	4E-17	JISSO PROTEC
TR (HK) COMPANY LIMITED	5E-08	PWB Technology
TSK	6B-03	Electronics Circuits Plaza
UMC ELECTRONICS	6A-12	Electronics Circuits Plaza
UNITECH	4F-22	JISSO PROTEC
Unitemp Japan	4A-20	JISSO PROTEC
Via Mechanics	6F-32	PWB Technology
WorldTect	6H-12	PWB Technology
W	5E-26	JISSO PROTEC
YAMAHA FINE TECHNOLOGIES	5G-32	JISSO PROTEC
YAMAHA MOTOR	5G-32	JISSO PROTEC
Yamashita Materials	5G-01	Flexible Printed Circuits Products Area
Yangzhou Elec&Etek Electronics	5E-12	PWB Technology
YASKAWA ELECTRIC	4A-12	JISSO PROTEC
Yokohama Systems	5H-05	WIRE Japan Show
Zhejiang LeuchTek Electronic	5E-13	PWB Technology
ZIFSense	4F-08	Smart Sensing

Floor Map / List of Exhibitors

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Academic Plaza

- 8B-17 Graduate School of Systems and Information Engineering, University of Tsukuba
- 8B-18 Graduate School of Science Kimura research group, Kobe University
- 8B-19 Ikeda lab., Dept. of Mech. Eng., Graduate School of Eng., Kagoshima University
- 8B-20 Information, Production and Systems Research Center, TATSUMI Lab., WASEDA University
- 8B-21 Graduate School of Science and Engineering, Kagoshima University
- 8B-22 Fac. of Eng., Shinsu Univ. / CITIZEN FINEDEVICE
- 8B-23 Information Technology Group, Tokyo Metropolitan Industrial Technology Research Institute
- 8B-24 Fac. of Eng., Shinsu Univ.
- 8B-25 Mechanical Engineering, Tokyo University of Science, Yamaguchi
- 8B-26 Department of Electronics and Control Engineering, National Institute of Technology, Nagano College / Advanced Magnetic Device Lab., Shinsu Univ. / Spin Device Technology Center (SDTC)
- 8B-27 Osaka Research Institute of Industrial Science and Technology
- 8B-29 Manufacturing System Design Laboratory, Doshisha University
- 8B-30 Collaborative Research Center, Meisei University
- 8B-31 Device Development Group, Research Institute for Electromagnetic Materials
- 8B-32 Department of Production Electronics and Information System Technology, Kinki Polytechnic College / TOTAS
- 8C-17 The Foundation for Technology Promotion of Electronic Circuit Board
- 8C-18 FRIS, Shimadzu Laboratory, Tohoku University
- 8C-19 College of Science and Technology, Nihon University
- 8C-20 Koiva Laboratory, Kanto Gakuin University/Graduate School of Engineering / Oki Engineering
- 8C-21 Intelligent Embedded System Laboratory, Department of Mechanical Science and Technology, Gunma University
- 8C-22 Koiva Laboratory, Kanto Gakuin University, Department of Chemistry / Phototechnica
- 8C-23 Inoue Lab., Graduate School of Science and Technology, Gunma University
- 8C-24 Materials & Surface Engineering Research Institute, Kanto Gakuin University
- 8C-25 Material Design Lab., National Institute of Technology, Gunma College
- 8C-26 Higashij Laboratory, The University of Tokyo
- 8C-28 Graduate School of Life Sciences, Nano Micro Medical Laboratory, Kyushu University / The University of Tokyo, Microsystem Integration and Packaging Laboratories / EXTCOM
- 8C-29 Yokohama National University / Yokohama Jisso Consortium (YJC)
- 8C-30 Department of Electronics, Kyushu University
- 8C-31 Molecular Recognition Chemistry Research Group, Osaka Prefecture Univ. / Green Chem
- 8C-32 Materials Process Lab., Dept. of Chemical Engineering, Graduate school of Engineering, Osaka Prefecture University
- 8D-31 KOSHIIJI LABORATORY, Tokyo Polytechnic University

eX-tech

- 8B-01 Sulfur Chemical Laboratory
- 8B-02 ESPCE
- 8B-03 Integral Geometry Science
- 8B-04 TOPRO TECHNO SERVICE
- 8B-05 OSAKA ORGANIC CHEMICAL INDUSTRY
- 8B-06 AWR Japan
- 8B-07 TOYOBO
- 8B-08 MANUFACTURING SOLUTION
- 8B-09 Andor System Support
- 8B-02 Ehime University
- 8B-03 ZUKEN
- 8C-04 Graduate School of Technology, Industrial and Social Sciences, Tokushima University
- 8C-05 Fujitsu
- 8C-06 TDS
- 8C-07 Mitsubishi Chemical
- 8C-08 YKXON International
- 8C-10 Arakawa Chemical Industries
- 8D-01 DIC
- 8D-02 WEL Plasma System Sales Div.
- 8D-03 HONNY CHEMICALS
- 8D-04 WEL Test Water Div.
- 8D-05 ATHENE
- 8D-06 OKAMOTO MACHINE TOOL WORKS
- 8D-07 Enplas Semiconductor Peripheral
- 8D-08 Plasma Ion Assit
- 8D-09 KANKYO RESILIENCE
- 8D-10 Chemtex
- 8E-01 FUJITSU QUALITY LABORATORY
- 8E-03 FUJIKURA KASEI
- 8E-05 AKITA CHEMICAL INDUSTRIES
- 8E-07 AKIMOKU IRON WORKS
- 8E-09 Shimada Appli

3D-MID Pavilion

- 7F-30-01 Ebin Denka Kogyo
- 7F-30-02 Molex Japan
- 7F-30-03 ZUKEN
- 7F-30-04 DAIEI ELECTRONICS
- 7F-30-05 Panasonic
- 7F-30-06 SANKYO KASEI / JOHMAN
- 7F-30-07 Japan MID Association
- 7F-30-08 MacDermid Performance Solutions Japan
- 7F-30-09 Techno Alpha
- 7F-30-10 LPKF Laser & Electronics
- 7F-30-11 YAMAMA MOTOR
- 7F-30-12 TAIYO INK MFG.
- 7F-30-13 FUJII (FUJI MACHINE MFG.)

7H- Keynote Speech



Company Name	Booth No.	Exhibition
Advanced Industrial Science and Technology (AIST)	7C-18	PWB Technology
AGFA Materials Japan	7B-10	PWB Technology
AKIMOKU IRON WORKS	8E-07	eX-tech
AKITA CHEMICAL INDUSTRIES	8E-05	eX-tech
Andor System Support	8C-01	eX-tech
Arakawa Chemical Industries	8C-10	eX-tech
ASKA ENGINEERING	7D-07	PWB Technology
atj Luther & Maelzer	7D-24	PWB Technology
ATHENE	8D-05	eX-tech
Atotech Japan	7A-16	PWB Technology
AURORA INDUSTRIES	7D-41	PWB Technology
AWR Japan	8B-06	eX-tech
Baoding Lucky Innovative Materials	7C-15	PWB Technology
BOWMAN	7C-20	PWB Technology
BSEF Japan	7C-05	PWB Technology
C. Uyemura	7B-09	PWB Technology
Chemtex	8D-10	eX-tech
CHIN YEE CHEMICAL INDUSTRIES	7D-46	PWB Technology
China Printed Circuit Association (CPCA)	8E-13	WECC
Chuo Musen Denki	8F-10	TEP Pavilion
CMK	7D-50	JPCA Challenge 2018
Collaborative Research Center, Meisei University	8B-30	Academic Plaza
College of Science and Technology, Nihon University	8C-19	Academic Plaza
DAIEI ELECTRONICS	7F-30-04	3D-MID
Daiva Musen Denki	8F-09	TEP Pavilion
DEMPA PUBLICATIONS	7D-45	PWB Technology
Department of Electronics and Control Engineering, National Institute of Technology, Nagano College / Advanced Magnetic Device Lab., Shinsu Univ.	8B-26	Academic Plaza
Nagano College / Advanced Magnetic Device Lab., Shinsu Univ.	8C-30	Academic Plaza
Department of Production Electronics and Information System Technology, Kinki Polytechnic College / TOTAS	8B-32	Academic Plaza
Device Development Group, Research Institute for Electromagnetic Materials	8B-31	Academic Plaza
DIC	8D-01	eX-tech
DKS	7D-46	PWB Technology
DU PONT-TORAY	7A-08	PWB Technology
DuPont Specialty Products	7A-08	PWB Technology
Ebin Denka Kogyo	7F-30-01	3D-MID
Elime University	8C-02	eX-tech
Electronic Industries Association of India (ELCINA)	8E-19	WECC
Electroplating Engineers of Japan	7A-44	PWB Technology
Enplas Semiconductor Peripheral	8D-07	eX-tech
ESPEC	8B-02	eX-tech
Eternal Materials	7C-20	PWB Technology
European Institute of Printed Circuits (EIPC)	8E-17	WECC
Everett / Charles Japan	7C-24	PWB Technology
Fac. of Eng., Shinsu Univ.	8B-24	Academic Plaza
Fac. of Eng., Shinsu Univ. / CITIZEN FINEDEVICE	8B-22	Academic Plaza
FISCHER INSTRUMENTS	7B-18	PWB Technology
FRIS, Shimadzu Laboratory, Tohoku University	8C-18	Academic Plaza
FUJII (FUJI MACHINE MFG.)	7F-30-13	3D-MID
FUJIFILM Global Graphic Systems	7A-47	PWB Technology
FUJIKURA KASEI	8E-03	eX-tech
Fujitsu Quality Laboratory	8C-05	eX-tech
Fukushima PR booth	7B-41	PWB Technology
Goal Searchers, ZHUHAI	7F-29	PWB Technology
GOD CHEMICAL	7A-38	PWB Technology
Graduate School of Life Sciences, Nano Micro Medical Laboratory, Kyushu University / The University of Tokyo, Microsystem Integration and Packaging Laboratories / EXTCOM	8C-28	Academic Plaza
Graduate School of Science and Engineering, Kagoshima University	8B-21	Academic Plaza
Graduate School of Science Kimura research group, Kobe University	8B-18	Academic Plaza
Graduate School of Systems and Information Engineering, University of Tsukuba	8B-17	Academic Plaza
Graduate School of Technology, Industrial and Social Sciences, Tokushima University	8C-04	eX-tech
Hamamatsu Kiban Kogyo	7D-50	JPCA Challenge 2018
HANAOKA MUSEN DENKI	8E-06	TEP Pavilion

Company Name	Booth No.	Exhibition
Nagano Prefectural Government	7A-37	PWB Technology
NAITO DENSEI KOGYO	8D-13	Microelectronics Show
NAKAJIMA KAGAKUSANGYO	7D-41	PWB Technology
NANVA NEW MATERIAL TECHNOLOGY	7C-47	PWB Technology
NIDECE-READ	7B-24	PWB Technology
NIHON KAGAKU SANGYO	7A-34	PWB Technology
NIHON PARKERIZING	7C-43	PWB Technology
NIKKAN INDUSTRIES	7D-50	JPCA Challenge 2018
Nikko-Materials	7C-02	PWB Technology
Nippon Electronic Device Industry Association	7D-11	PWB Technology
NIPPON MEKTRON	7D-50	JPCA Challenge 2018
Nippon Polytech	7E-38	PWB Technology
NIPPON TERPENE CHEMICALS	7C-11	PWB Technology
NORITAKE	7D-39	PWB Technology
Oji F-Tex	7A-39	PWB Technology
OKADA GAJ	7D-43	PWB Technology
OKAMOTO MACHINE TOOL WORKS	8D-06	eX-tech
Okamoto	7B-19	PWB Technology
OKUNO CHEMICAL INDUSTRIES	7C-05	PWB Technology
OSAKA ORGANIC CHEMICAL INDUSTRY	8B-05	eX-tech
Osaka Research Institute of Industrial Science and Technology	8B-27	Academic Plaza
PAN-TEC	7D-43	PWB Technology
Panasonic	7D-30	PWB Technology
Panasonic	7F-30-05	3D-MID
Plasma Ion Assit	8D-08	eX-tech
Printed Circuit Journal	7A-43	PWB Technology
PROCESS LAB. MICRON	7D-50	JPCA Challenge 2018
R-DENSHI	8F-14	TEP Pavilion
RISHO KOGYO	7E-40	PWB Technology
ROHM AND HAAS ELECTRONIC MATERIALS	7B-08	PWB Technology
SAFETY DENKI	8F-07	TEP Pavilion
SAKURA COLOR PRODUCTS	7D-12	PWB Technology
SAN-EI KAGAKU	7C-12	PWB Technology
SANKEI	7C-19	PWB Technology
SANKO GIKEN KOGYO	7D-43	PWB Technology
SANKYO KASEI	7F-30-06	3D-MID
Sankyosha	8F-02	TEP Pavilion
SATO PARTS	8E-04	TEP Pavilion
SHASHIN KAGAKU	7D-17	PWB Technology
SHENGG TI TECHNOLOGY	7D-34	PWB Technology
SHENZHEN JINZHOU PRECISION TECHNOLOGY	7B-37	PWB Technology
SHENZHEN NEWCESS INDUSTRIAL	7D-13	PWB Technology
SHIKOKU CHEMICALS	7A-12	PWB Technology
SHIKOKU CHEMICALS	7D-50	JPCA Challenge 2018
Shimada Appli	8E-09	eX-tech
Shinkasei (Shen Zhen) Trading / KSDW Plating Equipment	7A-29	PWB Technology
Shirai Electronics Industrial	7D-50	JPCA Challenge 2018
SMART VISION	7C-17	PWB Technology
Sojitz Pla-Net	7D-34	PWB Technology
SOMAR	7D-08	PWB Technology
Stella Corporation	7D-23	PWB Technology
Sulfur Chemical Laboratory	8B-01	eX-tech
TAIWAN KONG KING	7E-17	PWB Technology
Taiwan Printed Circuit Association (TPCA)	8D-14	WECC
TAIYO INDUSTRIAL	7B-15	PWB Technology
TAIYO INK MFG.	7D-50	JPCA Challenge 2018
TAIYO INK MFG.	7C-30	PWB Technology
TAIYO INK MFG.	7D-50	JPCA Challenge 2018
TAIYO INK MFG.	7F-30-12	3D-MID
TAKAGI SYSTEM	8F-13	TEP Pavilion
TAMURA	7C-29	PWB Technology
TANAKA MUSEN DENKI	8E-02	TEP Pavilion
TATSUTA Electric Wire & Cable	7C-08	PWB Technology
TCT(JAPAN)	7A-40	PWB Technology
TDS	8C-06	eX-tech
TECHNICAL	8D-15	Microelectronics Show
Techno Alpha	7F-30-09	3D-MID
TEG SOLUTION	8C-16	Microelectronics Show
Thanko	7D-15	PWB Technology
The Foundation for Technology Promotion of Electronic Circuit Board	8C-17	Academic Plaza
TOKYO KAKOKI	7D-01	PWB Technology
Tokyo Machine & Tool	7D-43	PWB Technology
TOKYO OHKA KOGYO	7B-30	PWB Technology
TOYOPRO TECHNO SERVICE	8B-04	eX-tech
TOYO-KEISOKUKI	8F-04	TEP Pavilion
TOYOBO	8B-07	eX-tech
TOYOCHOEM	7E-30	PWB Technology
Trillion-Node Study Group	7D-50	JPCA Challenge 2018
Tsunoda BRUSH	7B-33	PWB Technology
Tulip	7B-22	PWB Technology
UNION TOOL	7D-43	PWB Technology
USHIO	7B-25	PWB Technology
Ventec International Group	7B-32	PWB Technology
WELL Plasma System Sales Div.	8D-02	eX-tech
WELL Test Water Div.	8D-04	eX-tech
YAMAMA MOTOR	7F-30-11	3D-MID
YASUNAGA	7C-25	PWB Technology
YINGTIAN JIANGNAN COPPER INDUSTRY	7C-40	PWB Technology
Yokohama National University / Yokohama Jisso Consortium (YJC)	8C-29	Academic Plaza
YKXON International	8C-08	eX-tech
Zeon	7C-45	PWB Technology
Zhejiang Huanzheng New Material	7C-34	PWB Technology
ZUKEN	7F-30-03	3D-MID
ZUKEN	8C-03	eX-tech

The JPCA Award

The JPCA Award will be selected from the entries entered for the JPCA Award review from the "New Product Introduction (NPI) Presentation" introduction of products and new technologies.

Fukushima Prefecture PR booth
[Booth No. 7B-41]

Kumamoto Prefecture PR booth
[Booth No. 7B-42]

Food trucks or light snacks will be sold at places with this mark. Please feel free to make use of these services.

JPCA Challenge 2018 7D-50

CMK	PROCESS LAB. MICRON
Hamamatsu Kiban Kogyo	SHIKOKU CHEMICALS
KPD	Shirai Electronics Industrial
KYOSHA	TAIYO INDUSTRIAL
NIKKAN INDUSTRIES	TAIYO INK MFG.
NIPPON MEKTRON	Trillion-Node Study Group

For more information, visit our website.
www.jpca2018.com

Next Show Jun. 5-7, 2019
Tokyo Big Sight, West Hall

JPCA Show 2019 2019 Microelectronics Show

JISSO PROTEC 2019 Total Organic Devices Expo 2019

WIRE Japan Show 2019 Smart Sensing 2019